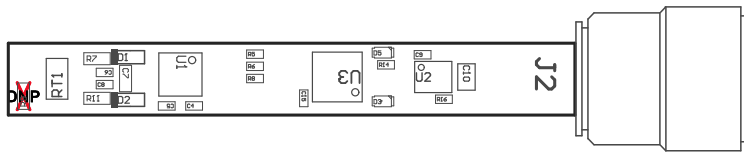


Z22 ■ This Assembly Note will show in the PcbDoc and associated outputs

Z23 ■ This Assembly Note will show in the PcbDoc and associated outputs

Z24 ■ This Assembly Note will show in the PcbDoc and associated outputs



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-01335	REV: E1	SUN REV: Not In VersionControl
	TID #: TIDA-01335		
PLOT NAME = Top Assembly Drawing	GENERATED : 7/18/2017 11:39:48 AM	TEXAS INSTRUMENTS	



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-01335	REV: E1	SUN REV: Not In VersionControl
	TID #: TIDA-01335		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 7/18/2017 11:39:50 AM	TEXAS INSTRUMENTS	

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